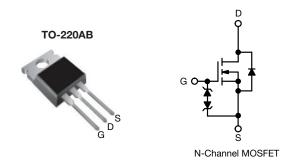
Vishay Siliconix

COMPLIANT

HALOGEN

**FREE** 

## **E Series Power MOSFET**



PRODUCT SUMMARY					
V <sub>DS</sub> (V) at T <sub>J</sub> max.	850				
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.826			
Q <sub>g</sub> max. (nC)	22.5				
Q <sub>gs</sub> (nC)	4				
Q <sub>gd</sub> (nC)	7				
Configuration	Single				

## **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low effective capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free and halogen-free	SiHP6N80AE-GE3		

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-source voltage			V <sub>DS</sub>	800	V		
Gate-source voltage			$V_{GS}$	± 30	V		
Continuous drain current (T <sub>J</sub> = 150 °C)	V <sub>GS</sub> at 10 V	$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$	- I <sub>D</sub>	5			
	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C		3.2	А		
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	10			
Linear derating factor				0.5	W/°C		
Single pulse avalanche energy b			E <sub>AS</sub>	20.3	mJ		
Maximum power dissipation			$P_{D}$	62.5	W		
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C		
Drain-source voltage slope $T_J = 125  ^{\circ}\text{C}$		1 / 11	100	\//			
Reverse diode dv/dt d		dv/dt	0.4	- V/ns			
Soldering recommendations (peak temperature) c For 10 s		For 10 s		260	°C		

### Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 140 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_{\alpha}$  = 25  $\Omega$ ,  $I_{AS}$  = 1.2 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C



# Vishay Siliconix

THERMAL RESISTANCE RATINGS						
PARAMETER	SYMBOL	TYP.	MAX.	UNIT		
Maximum junction-to-ambient	$R_{thJA}$	=	62	°C/W		
Maximum junction-to-case (drain)	$R_{thJC}$	-	2	C/VV		

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	800	-	-	V	
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	Reference to 25 °C, I <sub>D</sub> = 1 mA		0.8	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	$V_{DS} = V_{GS}, I_D = 250 \mu A$		-	4	V
Onto anima lankana		V <sub>GS</sub> = ± 20 V		-	-	± 10	0
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 \text{ V}$		-	± 50	μA
7			V <sub>DS</sub> = 800 V, V <sub>GS</sub> = 0 V		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 640 V	V <sub>DS</sub> = 640 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2 A	-	0.826	0.950	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 30 V, I <sub>D</sub> = 3 A		-	1.9	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$ f = 1  MHz		-	422	-	pF
Output capacitance	C <sub>oss</sub>			-	24	-	
Reverse transfer capacitance	C <sub>rss</sub>			-	4	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		-	17	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	92	-	
Total gate charge	Qg			-	15	22.5	
Gate-source charge	Q <sub>gs</sub>	$V_{GS} = 10 \text{ V}$	$V_{GS} = 10 \text{ V}$ $I_D = 3 \text{ A}, V_{DS} = 640 \text{ V}$		4	-	nC
Gate-drain charge	$Q_{gd}$			-	7	-	1
Turn-on delay time	t <sub>d(on)</sub>		'		12	24	- ns
Rise time	t <sub>r</sub>	$V_{DD} = 640 \text{ V}, I_D = 3 \text{ A},$		-	10	20	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		16	32	
Fall time	t <sub>f</sub>			-	20	40	
Gate input resistance	$R_g$	f = 1 MHz, open drain		1	2	4	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	showing the			-	5	
Pulsed diode forward current	I <sub>SM</sub>	integral reverse p - n junction diode		-	-	10	- A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 3 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 3 \text{A},$ $di/dt = 100 \text{A/\mu}\text{s}, V_R = 25 \text{V}$		-	285	570	ns
Reverse recovery charge	Q <sub>rr</sub>			-	1.7	3.4	μC
Reverse recovery current	I <sub>RRM</sub>			_	9.9	-	A

### Notes

- a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$
- b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 V to 480 V  $V_{DSS}$



## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

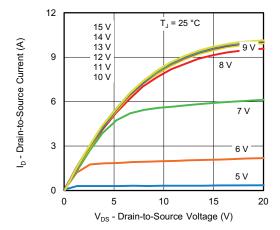


Fig. 1 - Typical Output Characteristics

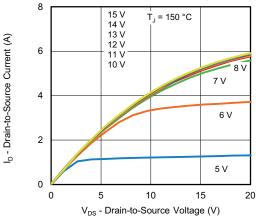


Fig. 2 - Typical Output Characteristics

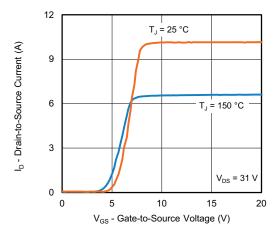


Fig. 3 - Typical Transfer Characteristics

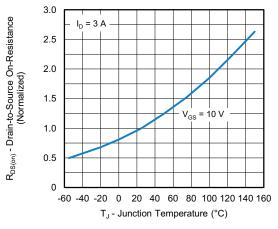


Fig. 4 - Normalized On-Resistance vs. Temperature

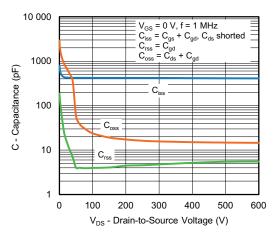


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

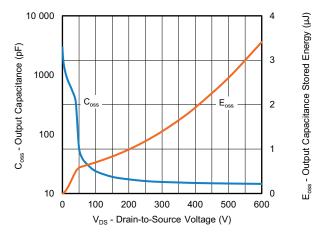


Fig. 6 - Coss and Eoss vs. VDS



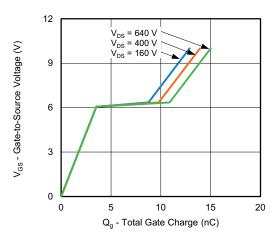


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

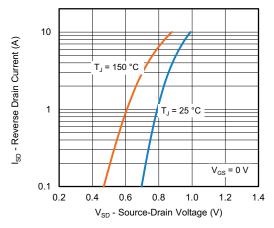


Fig. 8 - Typical Source-Drain Diode Forward Voltage

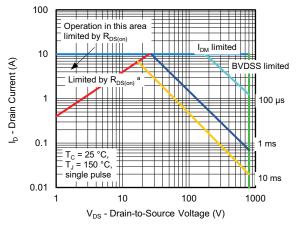


Fig. 9 - Maximum Safe Operating Area

## Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

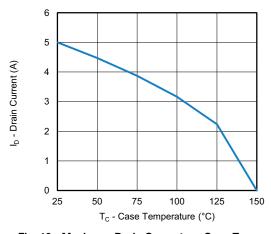


Fig. 10 - Maximum Drain Current vs. Case Temperature

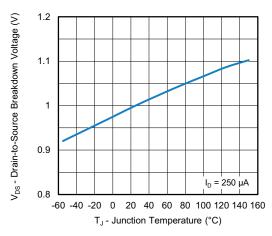


Fig. 11 - Temperature vs. Drain-to-Source Voltage



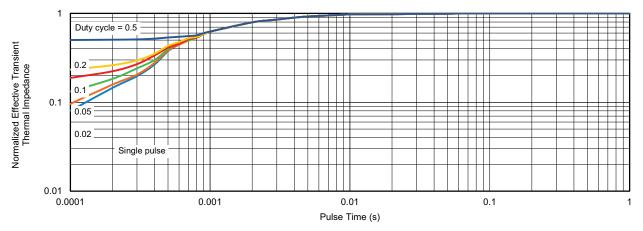


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

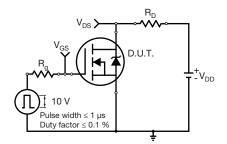


Fig. 13 - Switching Time Test Circuit

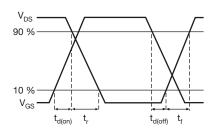


Fig. 14 - Switching Time Waveforms

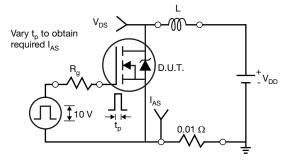


Fig. 15 - Unclamped Inductive Test Circuit

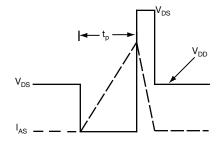


Fig. 16 - Unclamped Inductive Waveforms

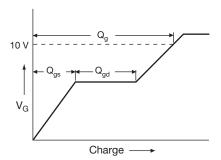


Fig. 17 - Basic Gate Charge Waveform

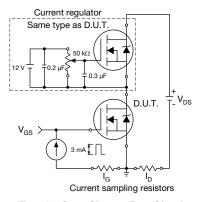
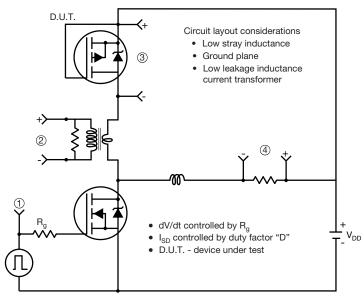


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



· Compliment N-channel of D.U.T. for driver

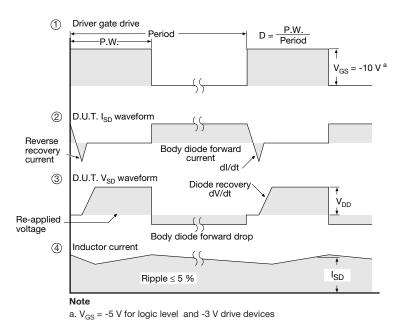


Fig. 19 - For N-Channel

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